



PREVIOUS CUI DEVICE'S DETAIL / IMAGE

SOLDERABILITY

parameter	conditions/description	min	typ	max	units
reflow storage	at relative humidity <80%			40	°C
reflow soldering	see reflow profile	255	260	265	°C
drying conditions <sup>1</sup>	parts in reel bake at 40°C-15°C for 72 hours parts removed from reel bake at 40°C-15°C for 10 hours				

Notes:  
1. Must reflow solder within 72 hours from opening vacuum packaging at a temperature 120°C-150°C relative humidity 90%  
2. When ascending from 150 to 170 hours

PACKAGING

units: mm  
Reel Size: Ø300 mm  
Reel QTY: 300 pcs per reel

Affected Date Code: **03/11/2023**

Product Availability: *Pertaining to market availability*

PCN Approval:

Operations/Quality



Product Management



F-723-001

Revision: A